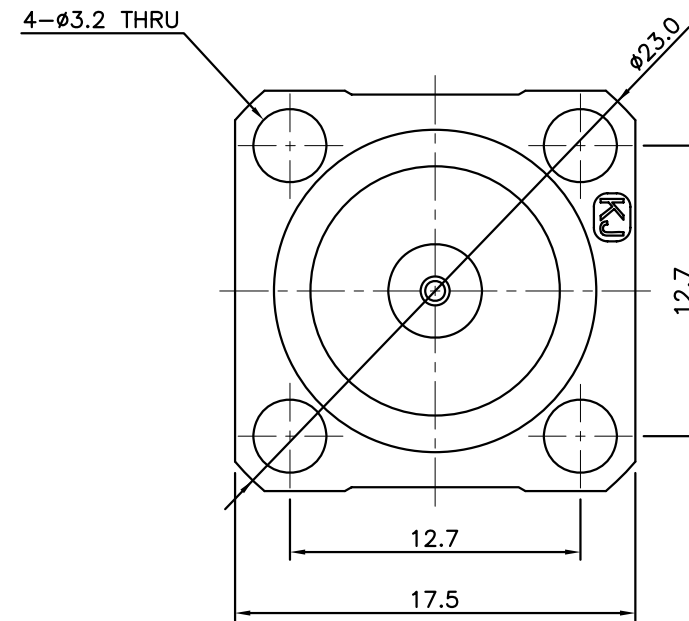
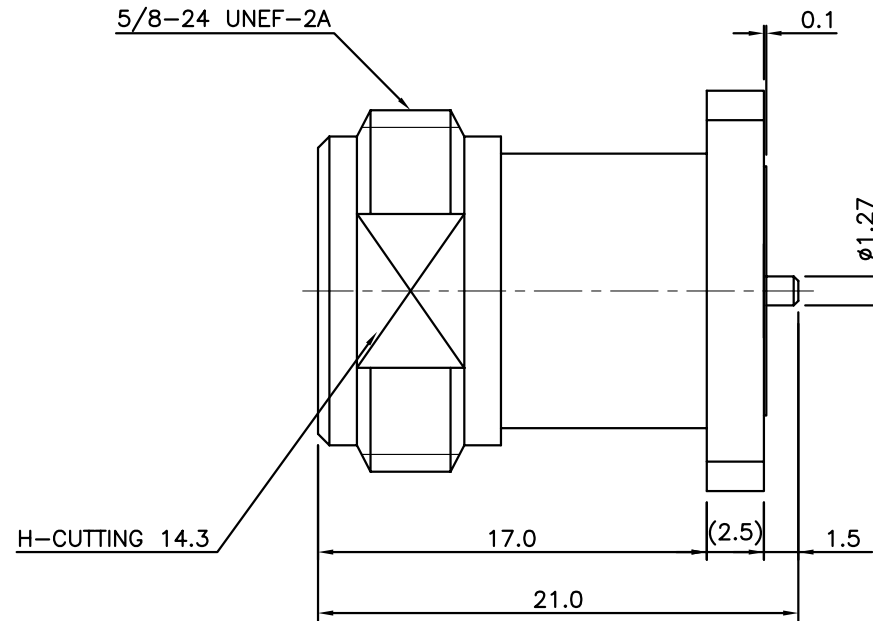


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.11.27.
1	[설번No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.
2	[설번No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.



4	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR01097-5/3 DSR01097-5/2 DSR01097-5/1
3	INSULATOR	1	TEFLON		DIN02813-N/2
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03741-5/4
1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 01. 20.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE N50 SOLDER END JS-4H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	3/1	A4 DWG NO. CN03958-7/7 REVISION 2 SHEET 1 of 1
		UNIT	mm	